



ENVIRONMENTAL AND PACKAGE TESTING DATA FOR PowerPAK® MLP33, 44, 55					
STRESS	SAMPLE SIZE	DEVICE HR./CYC	CONDITION	TOTAL FAILS	FAIL PERCENTAGE
HAST	490	49,000	130 °C, 85 % RH	0	0.00
Pressure Pot	490	47,040	121°, 15 PSIG	0	0.00
Solder Dunk	55	550	260 °C, 10 s	0	0.00
Temp. Cycle	562	295,474	- 65 °C to 150 °C	0	0.00